#### 506782200 07/23/2021

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6829017

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
ANDRE SCHEVCIW	07/22/2021
NILS GUNTHER PETERS	07/08/2021
ISAAC GARCIA MUNOZ	07/07/2021
VINAY MELKOTE KRISHNAPRASAD	07/01/2021

## **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17360950

## **CORRESPONDENCE DATA**

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 512-200-9737

npasarya@mooreiplaw.com Email: **Correspondent Name:** MOORE IP/QUALCOMM Address Line 1: 13359 N HWY 183, #406-243

Address Line 4: AUSTIN, TEXAS 78750

ATTORNEY DOCKET NUMBER:	205331U2
NAME OF SUBMITTER:	NISHI PASARYA
SIGNATURE:	/Nishi Pasarya/
DATE SIGNED:	07/23/2021

**Total Attachments: 12** 

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WHEREAS, WE,

- 1. Andre SCHEVCIW, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121,
- 2. **Nils Gunther PETERS,** having a mailing address located at 5775 **Morehouse Drive, San Diego, CA 92121**,
- 3. Isaac Garcia MUNOZ, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121
- 4. Vinay MELKOTE KRISHNAPRASAD, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **SOUND FIELD ADJUSTMENT** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 17/360,950 filed June 28, 2021, Qualcomm Reference Number 205331U2, and all provisional applications relating thereto, together with U.S Provisional Application No(s). 63/045,297, filed June 29, 2020, Qualcomm Reference Number 205331P1, and 63/053,331, filed July 17, 2020, Qualcomm Reference Number 205331P2 (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at ANDIEGO, CA, USA, on 07/22/2021 Olde Men.

City, State, Country Date Andre SCHEVCIW

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on		
	City, State, Country		Date	<b>Nils Gunther PETERS</b>
Done at		, on		
	City, State, Country		Date	Isaac Garcia MUNOZ
_				
Done at		, on		
	City, State, Country		Date	Vinay MELKOTE KRISHNAPRASAI

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WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

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AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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Done at	.0	n	
	City, State, Country	Date	Andre SCHEVCIW

PATENT
Qualcomm Reference Number: 205331U2
Page 3 of 3

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Done at	Erlandu, Garmas on 7/8	8/21	N/15 Pclos
	Every General on 7/8 City, State, Country	Date	Nils Gunther PETERS
Done at	, on		
	City, State, Country	Date	Isaac Garcia MUNOZ
Done at	, ón		
	City, State, Country	Date	Vinay MELKOTE KRISHNAPRASAD

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	City, State, Country	Date	Andre SCHEVCIW	

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Done at			
	City, State, Country	Date	Nils Gunther PETERS
Done at-	<u> </u>	1515L	L.A.Z.
**************************************	City, State, Country	Date	Isaac Garcia MUNOZ
Done at	, on		
	City, State, Country	Date	Vinay MELKOTE KRISHNAPRASAD

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Qualcomm Reference Number: 205331U2
Page 3 of 3

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Done at	, on		
	City, State, Country	Date	Nils Gunther PETERS
Done at	, on		
	City, State, Country	Date	Isaac Garcia MUNOZ
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	Bangalore, Karnataka, India	81 T. J. 2021	1 Air and Il
Done at	Karnasaka, Inda		
	City, State, Country	Date	Vinay MELKOTE KRISHNAPRASAD

PATENT REEL: 056958 FRAME: 0838

**RECORDED: 07/23/2021**